

Amendments to the Abstract:

Please replace the Abstract with the following:

[[The present invention discloses a]] A cooling structure for electronic devices
[[which is characterized in that]] includes a plurality of electronic device accommodating
boxes, in which electronic devices are accommodated, [[are accommodated]] disposed in a
casing in multiple stages. [[, a]] A vent portion which allows ventilation between the inside
and the outside of the casing is formed in a ceiling of the casing. [[, in]] In a first
accommodating portion for accommodating the first electronic device accommodating box
which is defined at the stage close to the ceiling, a hollow duct having two opening faces is
arranged. [[, the]] The first opening face faces the vent portion and the second opening face
faces a second accommodating portion for accommodating the second electronic device
accommodating box which is defined at the stage remote from the ceiling. [[, air]] Air inside
the second electronic device accommodating box ~~which is accommodated in the second
accommodating portion~~ is discharged ~~outside the casing from the vent portion~~ through the
inside of the duct. [[, and air]] Air inside of the first electronic device accommodating box
~~which is accommodated in the first accommodating portion~~ is discharged to the outside of the
casing from the vent portion ~~along an outer wall surface of the duct.~~